



PC13X02 V0

Product Specification

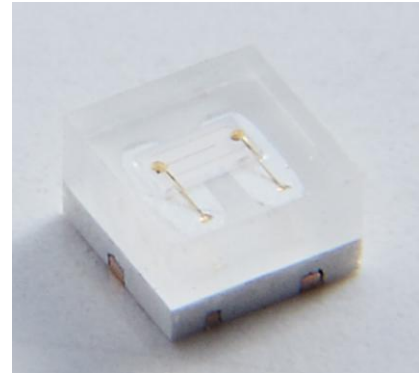
Approval Sheet

PC13X02 V0

Product Specification

RoHS

Product	Color CSP LED
Part Number	PC13X02 V0
Issue Date	2018/09/25



■ Feature

- ✓ Color 1313 CSP LED (L x W x H) of 1.3 x 1.3 x 0.75 mm
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 3
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 1,000 or 3,000 pcs/reel

■ Applications

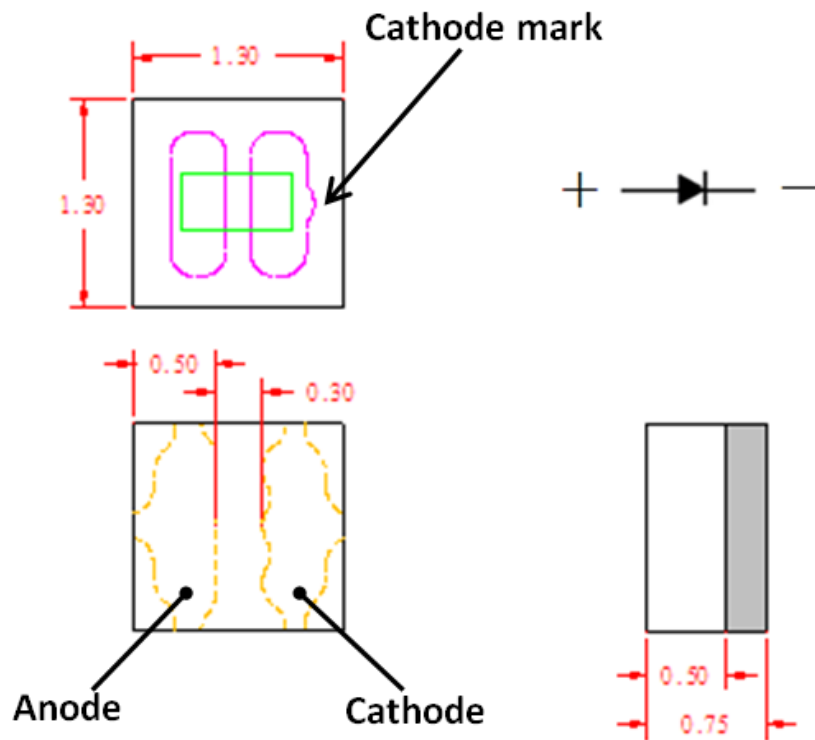
- ✓ Horticulture Lighting
- ✓ Backlighting
- ✓ Signaling
- ✓ Exterior Automotive Lighting
- ✓ Automotive Interior Lighting

Outline Dimension

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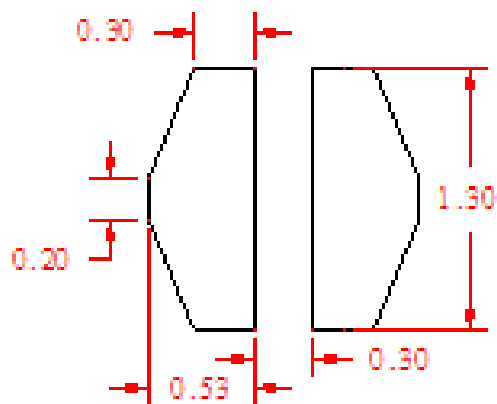
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Outline (Red/Green/Blue)



Unit: mm, Tolerance: ± 0.1 mm

Recommended Soldering Pad:



Performance

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■ **Optical Characteristics at 100mA(Tj=25°C)**

Color	P/N	Dominant Wavelength λ_D		
		Min.	Typ.	Max.
Red	95.C1313.RRC000Z	615 nm	620 nm	625 nm
Green	95.C1313.GGC000Z	518 nm	523 nm	528 nm
Blue	95.C1313.BDC000Z	452 nm	457 nm	462 nm

* Lextar maintains a tolerance of +/-1nm on wavelength measurements

■ **Electrical Characteristics (Tj=25°C)**

Color	Forward Voltage Vf(V) @100mA			View Angle(degrees) $2\theta_{1/2}$
	Min.	Typ.	Max.	
Red	2.6	2.86	3.1	140
Green	3.1	3.35	3.6	140
Blue	3.2	3.49	3.7	140

* The Forward Voltage tolerance is $\pm 0.1V$

* Thermal resistance is calculated from junction to solder

■ **Flux Characteristics (Tj=25°C)**

Color	Luminous Flux (lm) or Power (mW) @100mA			unit
	Min.	Typ.	Max.	
Red	12	15.8	20	Lm
Green	33	41.3	50	Lm
Blue	5	6.84	9	Lm

* Lextar maintains a tolerance of +/-7% on flux and power measurements

* Please do not drive at rated current more than 1 second without proper heatsink

■ **Absolute Maximum Ratings**

Parameter	Symbol	value	Unit
DC Forward Current	I_F	150	mA
Power Dissipation	P_d	0.6	W
Pulse Forward Current	I_{FP}	300	mA
Storage Temperature	T_s	-40 ~ 120	°C
Operating Temperature	T_{opr}	-40 ~ 90	°C
Junction Temperature	T_J	120	°C
Soldering Temperature	T_{sol}	260 (max. 5 sec)	°C

* Proper current rating must be observed to maintain junction temperature below maximum at all time

* IFP Condition: Duty 1/10, Pulse within 10msec

Ordering Code

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P C 1 3 X 0 2 0 - R 0 0 R 0 2 L F L I 5 A - 0 0 0

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23
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Item	Pos.	Code	Spec
Model Name	1-8	PC13X020	PC13X02 V0
Wd	9-14	R00R02 B01B02 G00G02	R00,R01,R02 B01,B02 G00,G01,G02
IV Bin Group	15-18	LFLI LOLS L9LC	Bin code : LF,LG,LH,LI Bin code : LO,LP,LQ,LR,LQ,LR,LS Bin code : L9,LA,LB,LC
Vf Bin Group	19,20	5A	Bin code : 5,6,7,8,9,A
Special Requirement	21-23	000	No requirement

Standard Ordering Code:

Color	Ordering Code ⁽¹⁾	Wd Bin Group	IV Bin Group	Vf Bin Group
Red	PC13X020-RRR00R02LFLI-570	R00, R01, R02	LF, LG, LH, LI	5, 6, 7
Green	PC13X020-GGG00G02LOLS-790	G00, G01, G02	LO, LP, LQ, LR, LS	7, 8, 9
Blue	PC13X020-BBB01B02L9LC-8A0	B01, B02	L9, LA, LB, LC	8, 9, A

(1) Only under an agreement between customer and Lextar Electronics, Ordering codes not in "Standard Ordering Code Definitions" can be supplied.

Binning

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Bin code definition(for example)

V _F Rank	Luminous Flux Rank	Wd
5	LF	R00

Forward Voltage Bin Structure @ 100mA

Color	Bincode	Voltage (V)	
		min	max
Red	4	2.4	2.6
	5	2.6	2.8
	6	2.8	3.0
	7	3.0	3.2
Green	7	3.0	3.2
	8	3.2	3.4
	9	3.4	3.6
Blue	7	3.0	3.2
	8	3.2	3.4
	9	3.4	3.6
	A	3.6	3.8

* The Forward Voltage tolerance is $\pm 0.1V$

■ Radiometric Luminous Flux Bin Structure @ 100mA

Color	Bincode	Luminous Flux (Lm)	
		min	max
Red	LF	12	14
	LG	14	16
	LH	16	18
	LI	18	20
Green	LO	33	36
	LP	36	39
	LQ	39	42
	LR	42	46
	LS	46	50
Blue	L9	5	6
	LA	6	7
	LB	7	8
	LC	8	9

* Lextar maintains a tolerance of +/-7% on flux and power measurements

* the flux bin of the product may be modified for improvement without notice.

■ Dominant Wavelength Bin Structure @ 100mA

Color	Bincode	Wavelength (nm)	
		min	max
Red	R00	615	620
	R01	620	625
Green	G00	515	520
	G01	520	525
	G02	525	530
Blue	B01	457	460
	B02	460	465

* Lextar maintains a tolerance of +/-1nm for dominant wavelength measurements

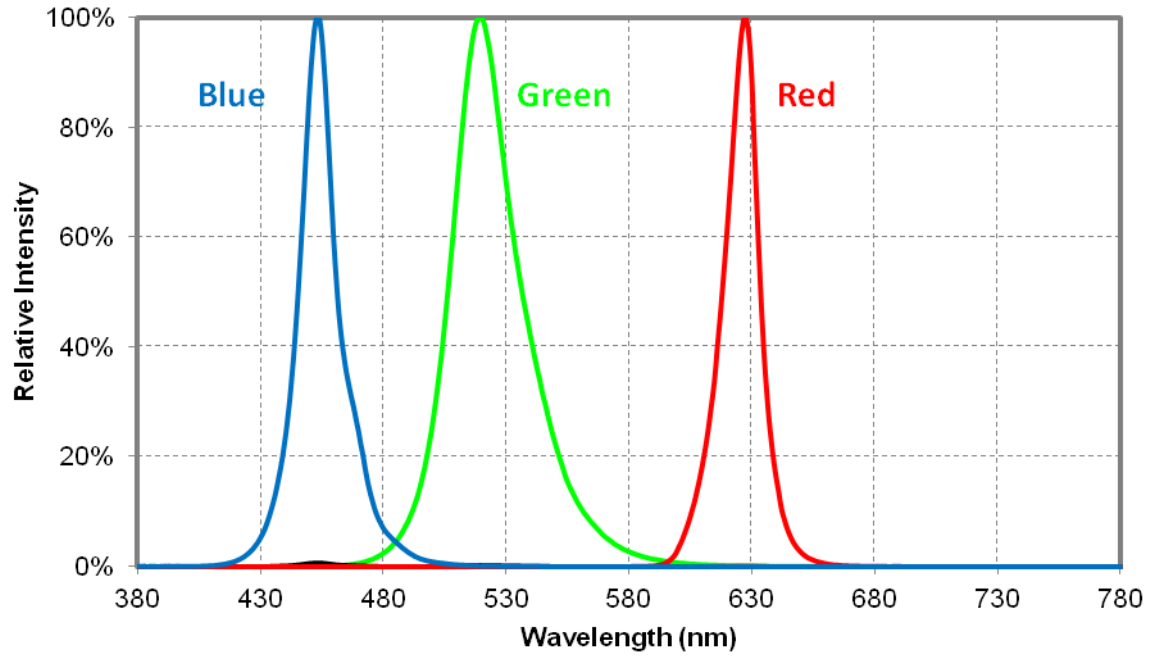
Characteristics

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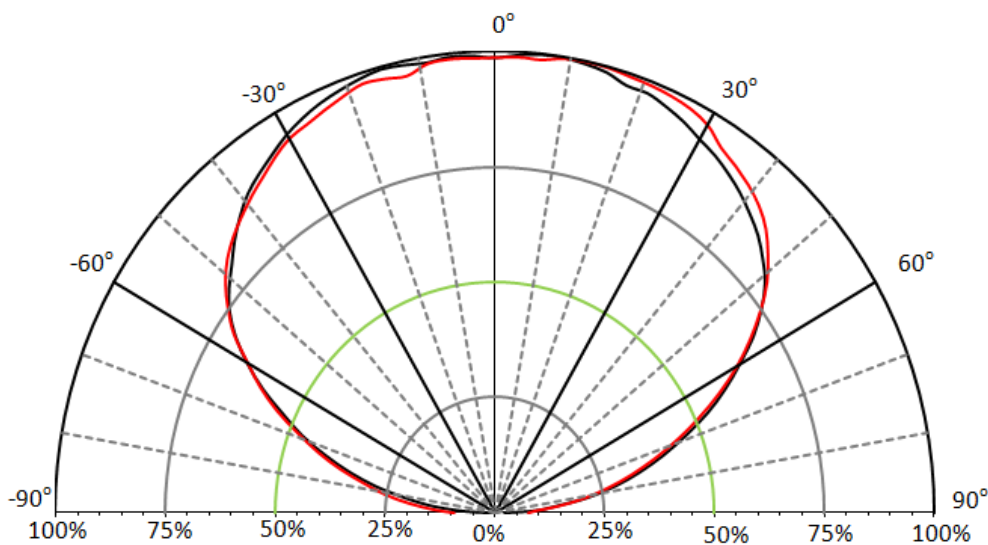
■ Color Spectrum, T_j=25C

Blue & Green & Red

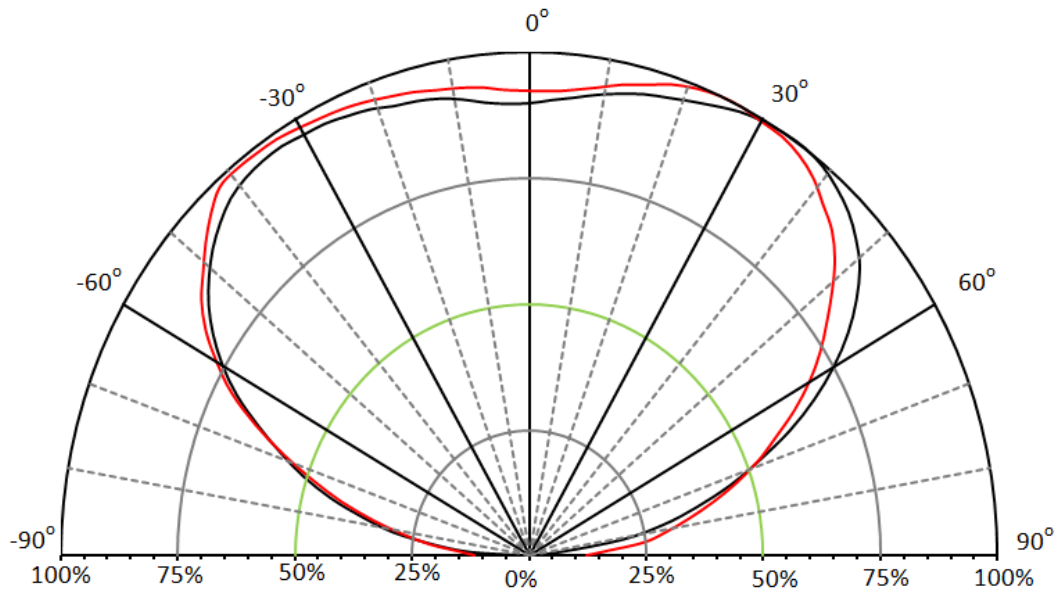


■ Typical Representative Spatial Radiation Pattern

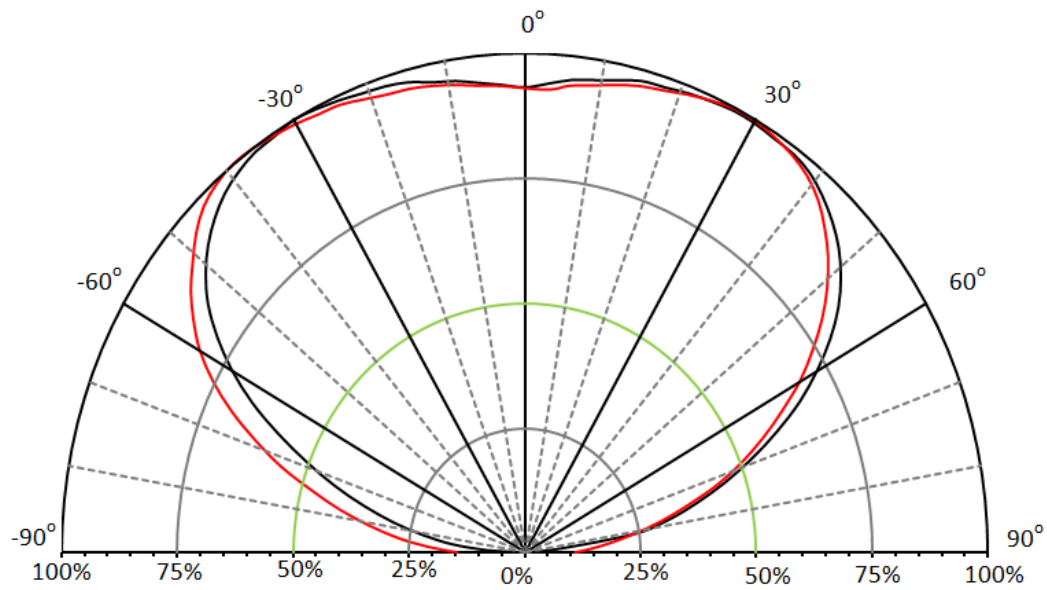
Red



Green

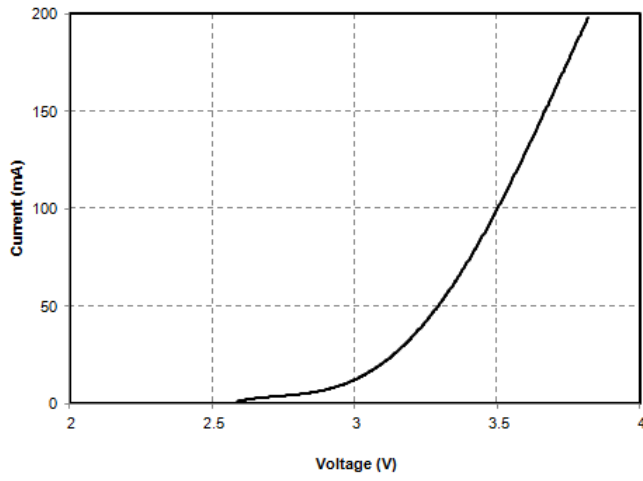


Blue

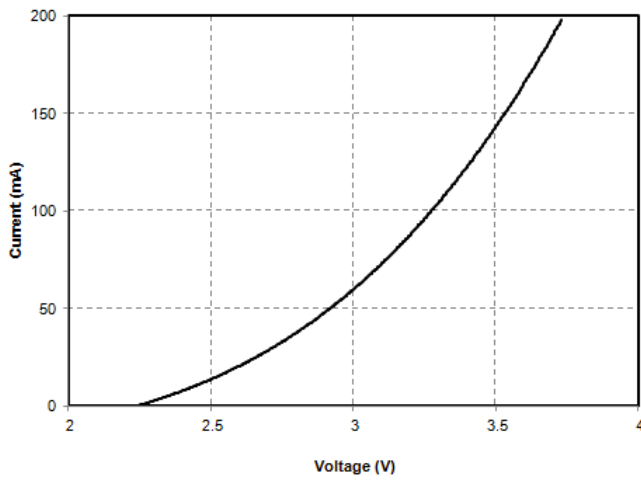


■ **Forward Voltage Vs. Forward Current , T_j=25C**

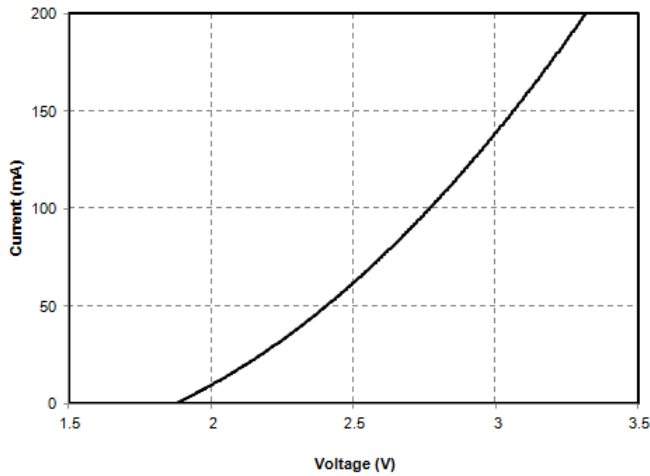
Blue



Green

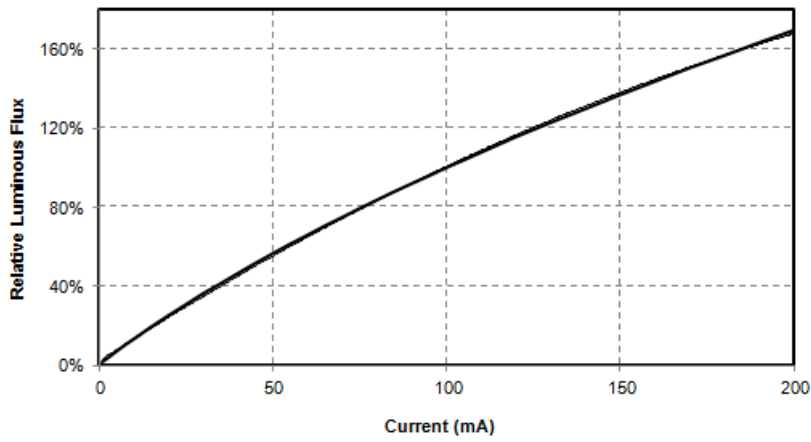


Red

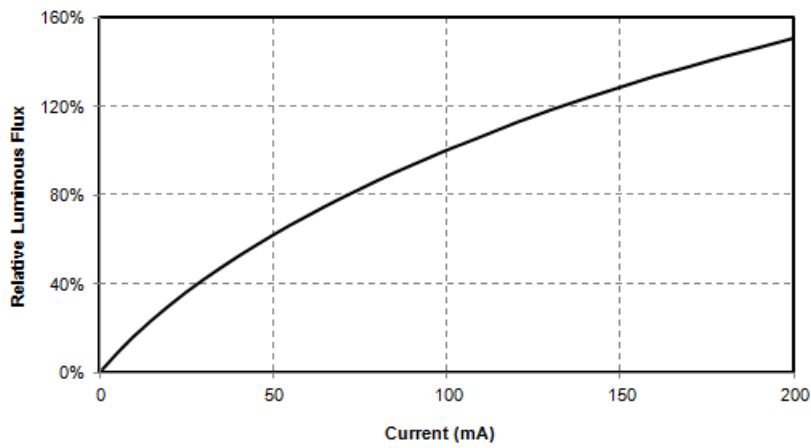


■ **Forward Current Vs. Normalized Relative Luminous Flux, T_j=25C**

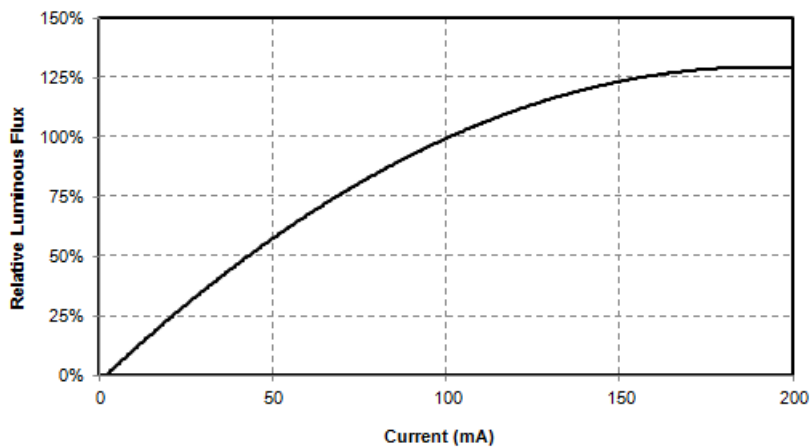
Blue



Green

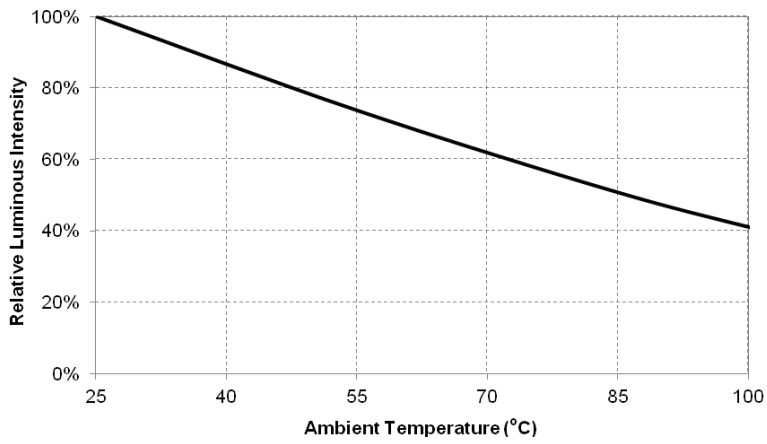


Red

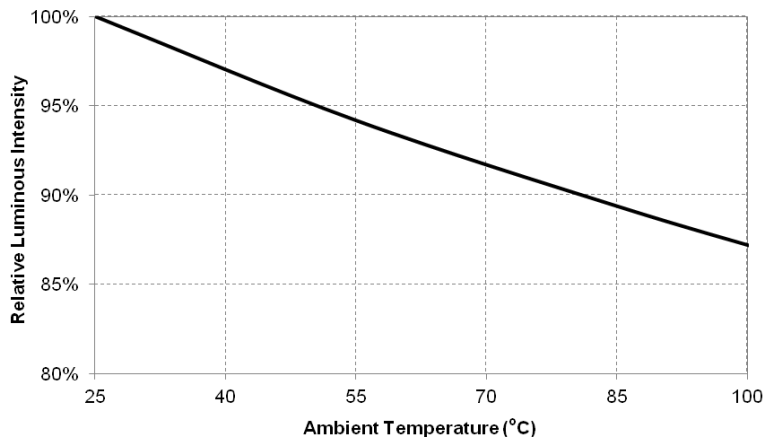


■ Relative Luminous Intensity vs. Ambient Temperature

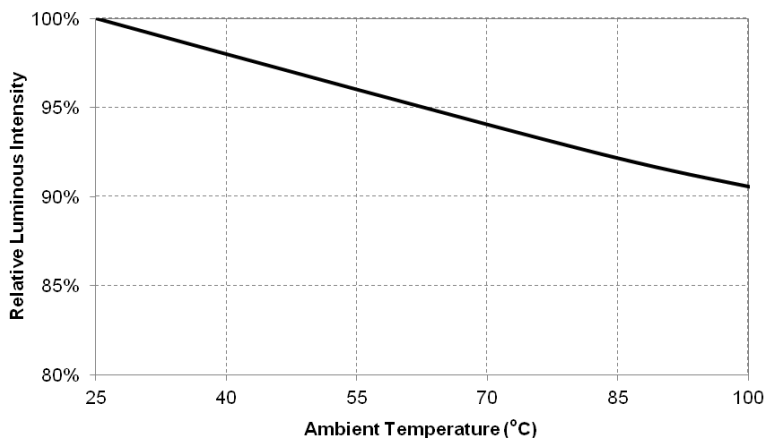
Red



Green

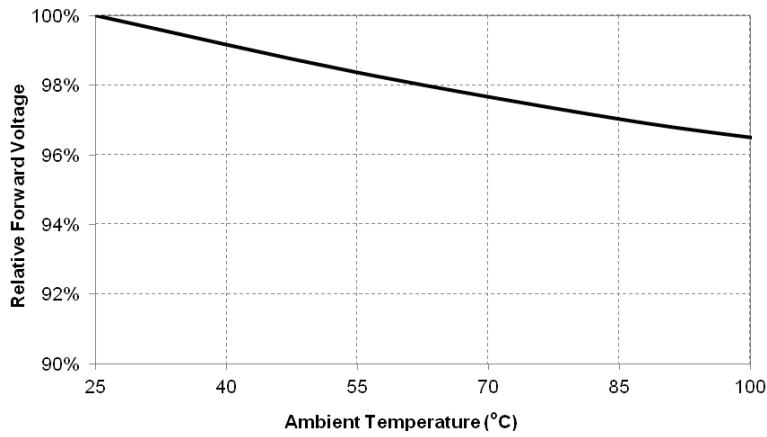


Blue

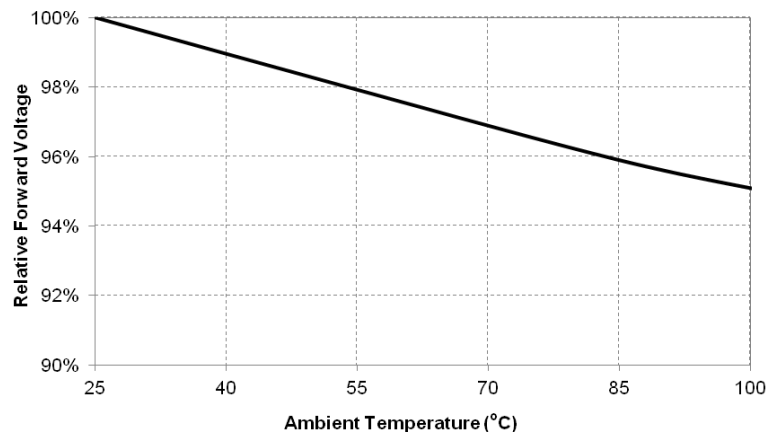


■ Ambient Temp. Vs Max. Forward Current

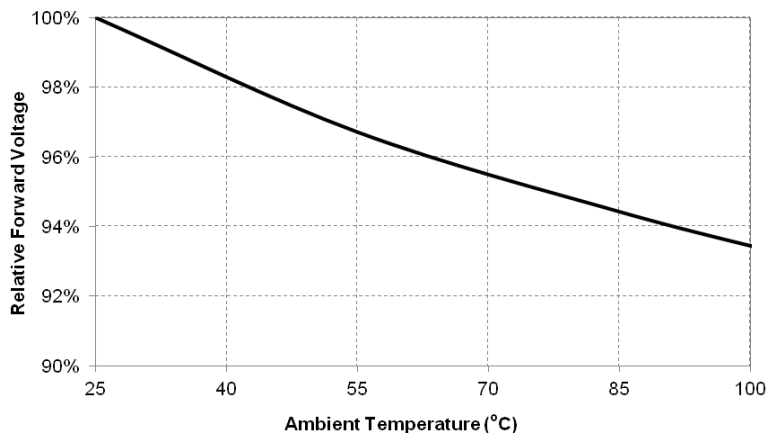
Red



Green



Blue



Reliability

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Reliability test

Item	Condition	Time/Cycle
Steady State Operating Life of High Temperature 25°C	25°C Operating	1000 Hrs
High Humidity Heat 85°C 85% s Operating	85°C/85% Operating	1000 Hrs
Low temperature storage -40°C	-40°C Storage	1000 Hrs
High temperature storage 100°C	100°C Storage	1000 Hrs
High Humidity Heat 85°C 85% storage	85°C/85% Storage	1000 Hrs
Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60°C, 60%RH for 52hrs Tsltd max.=260°C 10sec	1 cycle 3 Times
Thermal shock	-40°C/20minr ~5minr ~ 100°C/20min	200 Cycles

Judgment Criteria

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	100 mA	$\Delta V_f < 10 \%$
Luminous Flux	Iv	100 mA	$\Delta I_v < 30 \%$

Packing

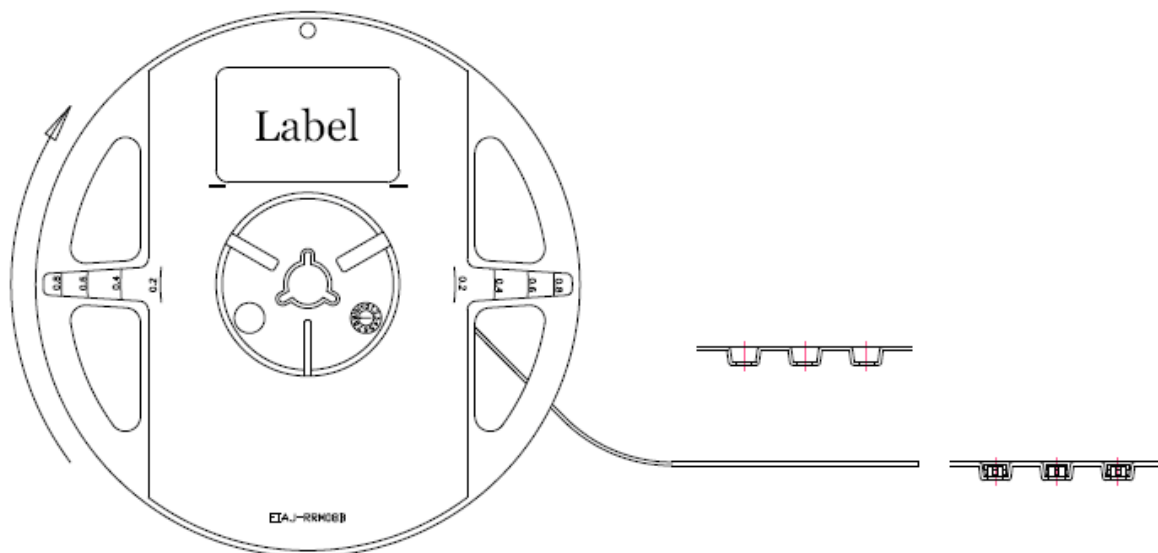
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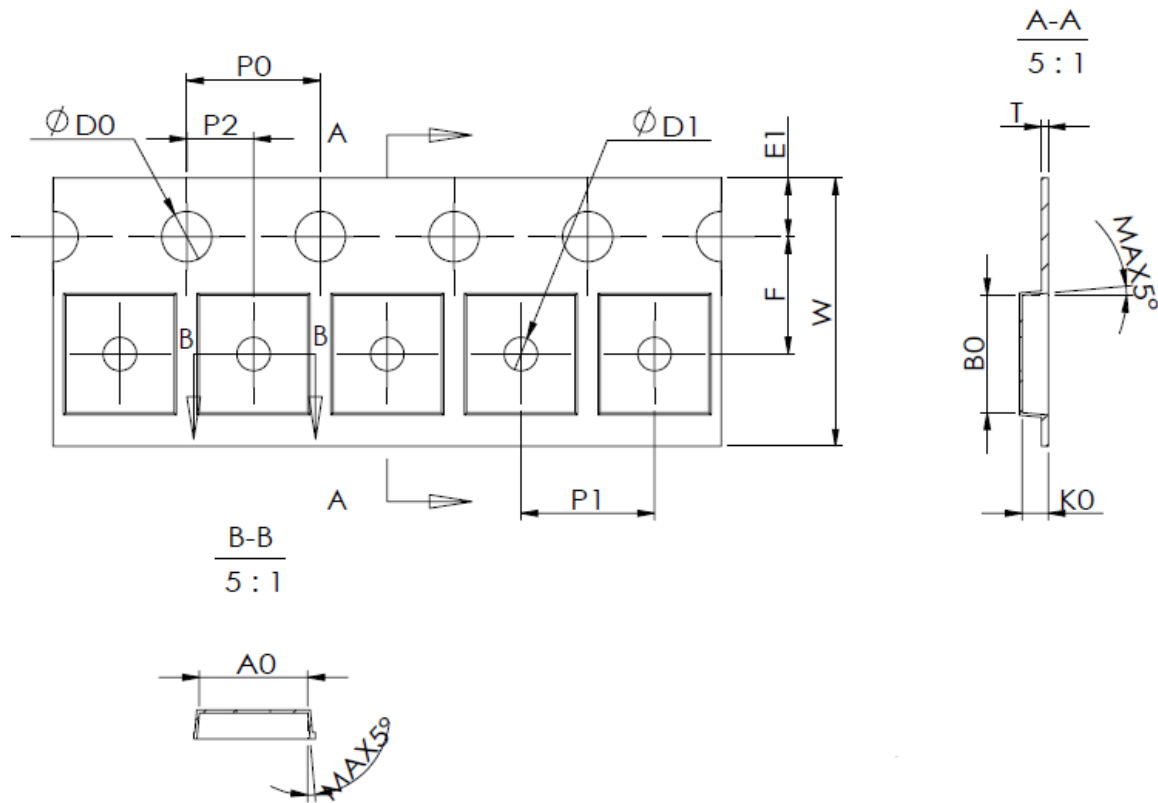
Product Specification

Label



Carrier Taping





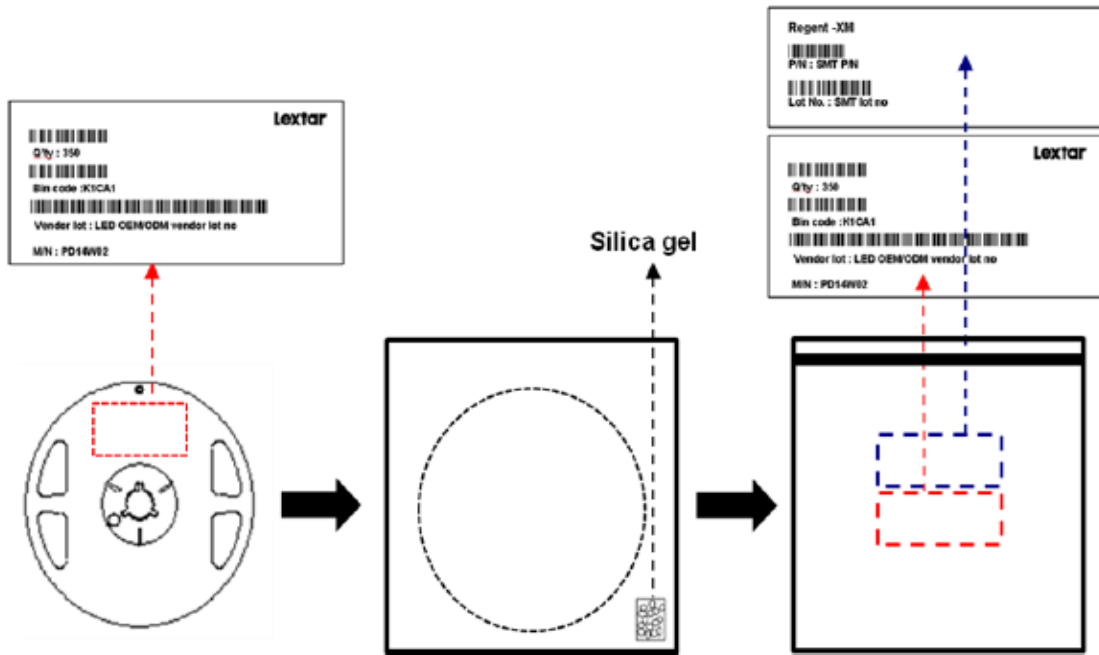
W	P1	E1	F	D0	D1
8.0	4.0	1.75	3.5	1.5	1.0
P0	P2	A0	B0	K0	T
4.0	2.0	3.25	3.5	0.8	0.22

PS : unit : mm

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is ± 0.20 mm.
2. Carrier camber shall be not more than 1mm per 100mm through a length of 250mm.
3. A0 & B0 measured on a place in the middle of the corner radii.
4. K0 measured from a place on the inside bottom of the pocket to top surface of carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Surface resistivity $10^4 \sim 10^8$ ohm/sq.

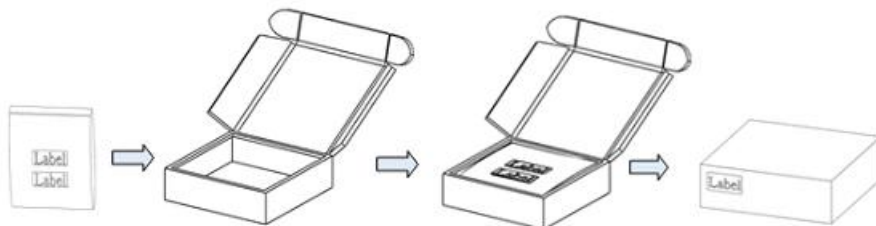
Shield Bag Taping



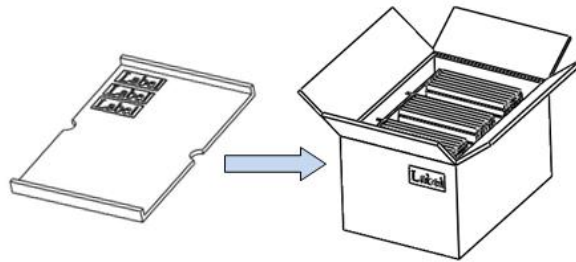
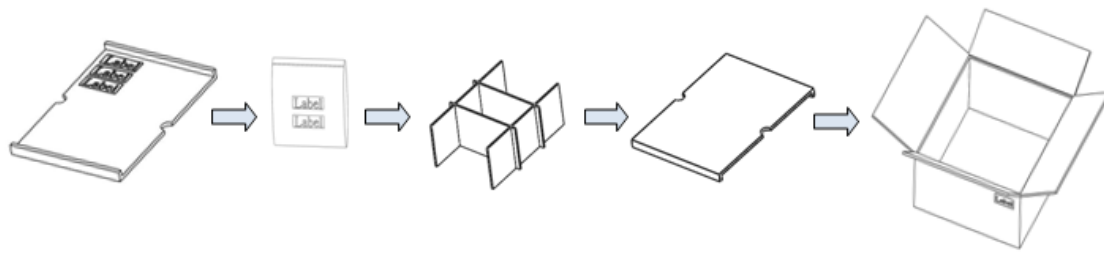
Packing Box

Type	Large Box		Medium Box		Small Box	
Dimension	541X511X276mm		385X303X260mm		283X235x70mm	
Maximum Reels	7"X8mm Reel	64/R	7"X8mm Reel	21/R	7"X8mm Reel	4/R
Minimum Reels	7"X8mm Reel	32/R	7"X8mm Reel	9/R	7"X8mm Reel	1/R

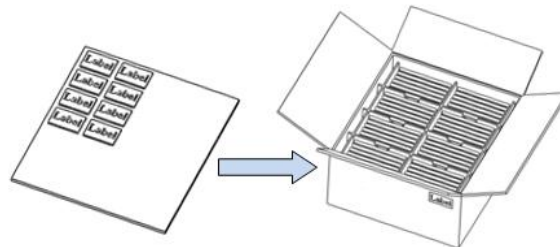
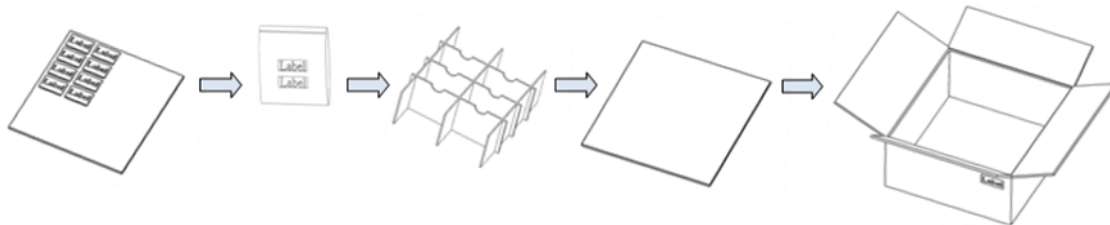
Small Box



■ **Medium Box**



■ **Large Box**



Precautions

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■ Safety Precautions

- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

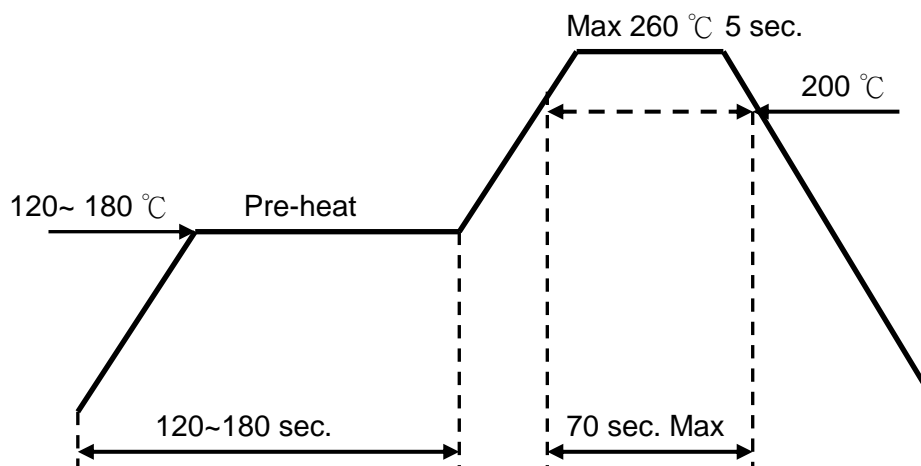
■ Storage

- Before opening the package, the LEDs should storage under 30°C, 70% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 70% RH. Recommend to use within 168 hours. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel. Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.

Bake condition: 60°C, 12hours (One time only).

■ Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
Hand soldering: 350 °C max , 3 sec. max.
Reflow soldering: Pre-heat 180 °C max , 180 sec. max.
Peak 260°C max , 5 sec. max.
- Reflow temperature profile as below: (lead-free solder)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

■ Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

■ Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.

Revision History

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Date	Contents	Writer	Approved
2018.09.28	Preliminary edition	Bug Huang	Ching Chen
2018.12.10	Formal edition	Bug Huang	Ching Chen
2018.12.19	Add ordering code	Bug Huang	Ching Chen
2019.01.25	Add Vf bin: 4	Bug Huang	Ching Chen
2019.03.18	Revise ordering code	Bug Huang	Ching Chen

Smart Lighting *Amazing Life*

Lextar Electronics Corp. is the leading LED (Light Emitting Diode) maker integrating upper stream epitaxial, middle stream chip, and downstream package, SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics, the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight. Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China.